

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 16 D-32758 Detmold

Germany

Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com















High-temperature-resistant, double-row pin header for all common soldering methods. Optimised for automatic assembly. Packed in box or tape. Solder pin 3.2 mm long, suitable for reflow and wave soldering. The male connectors provide space for labelling and can be coded.

General ordering data

Туре	S2L-SMT 3.50/04/180G 3.5SN BK BX
Order No.	<u>1924530000</u>
Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 3.50 mm, No. of poles: 4, 180°, Solder pin length (I): 3.5 mm, tinned, Black, Box
GTIN (EAN)	4032248564040
Qty.	222 pc(s).
Product data	IEC: 160 V / 10 A UL: 150 V / 10 A
Packaging	Box



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Technical data

Dimensions and weights

Width	8.4 mm	Width (inches)	0.331 inch
Height	14.3 mm	Height (inches)	0.563 inch
Height of lowest version	14.2 mm	Depth	10.8 mm
Depth (inches)	0.425 inch	Net weight	1.5 g

System specifications

Product family	OMNIMATE Signal - series B2L/S2L 3.50 - 2-row	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	180°
No. of poles	4	Number of solder pins per pole	1
Solder pin length (I)	3.5 mm	Tolerance of solder pin position	± 0.1 mm
Solder pin dimensions	d = 1.0 mm, Octagonal	Solder eyelet hole diameter (D)	1.3 mm
Solder eyelet hole diameter tolerance	D)+ 0,1 mm	Outside diameter of solder pad	2.1 mm
Template aperture diameter	1.9 mm	L1 in mm	3.5 mm
L1 in inches	0.138 inch	Number of rows	1
Pin series quantity	2	Touch-safe protection acc. to DIN VDE 57 106	Safe from back-of-hand touch
Touch-safe protection acc. to DIN VDE		Can be coded	
0470	IP 10		Yes
Plugging cycles	25	Plugging force/pole, max.	3 N
Pulling force/pole, max.	6 N		

Material data

Insulating material	LCP GF	Colour	Black
Colour chart (similar)	RAL 9011	Insulating material group	IIIb
СТІ	≥ 175	Insulation resistance	≥ 10 ⁸ Ω
Moisture Level (MSL)	1	UL 94 flammability rating	V-0
Contact material	Copper alloy	Contact surface	tinned
Layer structure of solder connection	2-3 μm Ni / 5-7 μm Sn glossy	Storage temperature, min.	-25 ℃
Storage temperature, max.	55 °C	Max. relative humidity during storage	80 %
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-30 °C	Temperature range, installation, max.	100 °C

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. no. of poles (Tu=20°C)	10 A
Rated current, max. no. of poles (Tu=20°C)	10 A	Rated current, min. no. of poles (Tu=40°C)	9 A
Rated current, max. no. of poles Tu=40°C)	8.5 A	Rated voltage for surge voltage class / pollution degree II/2	160 V
Rated voltage for surge voltage class / pollution degree III/2	125 V	Rated voltage for surge voltage class / pollution degree III/3	50 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	1.5 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	1.5 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	2.5 kV	Short-time withstand current resistance	3 x 1s with 77 A



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Technical data

Institute (CSA)	@	Certificate No. (CSA)	
	(SÐ∗		
			200039-1176845
Rated voltage (Use group B)	50 V	Rated voltage (Use group C)	50 V
Rated voltage (use group D)	150 V	Rated current (use group B)	5 A
Rated current (use group C)	9.5 A	Rated current (use group D)	9.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Rated data acc. to UL 105	9		
nstitute (UR)		Certificate No. (UR)	
istitute (On)		Certificate No. (ON)	
	44.1		
	<i>-</i>		E60693
Rated voltage (use group B)	150 V	Rated voltage (use group C)	50 V
Rated current (use group B)	10 A	Rated current (use group C)	10 A
Reference to approval values	Specifications are	(ў. с. гр. с.)	
	maximum values, details - see approval certificate.		
Packaging			
Packaging	Вох	VPE length	30 mm
/PE width	135 mm	VPE height	350 mm
Classifications		T. I morgini	
iassifications			
TIM 4.0	EC002637	ETIM 5.0	EC002637
TIM 6.0	EC002637	UNSPSC	30-21-18-10
Class 5.1	27-26-07-01	eClass 6.2	27-26-07-04
eClass 7.1	27-44-04-02	eClass 8.1	27-44-04-02
Class 9.0	27-44-04-02	eClass 9.1	27-44-04-02
lotes			
lotes	Additional colours on reques	t	
	, taattorial colours on reques	•	
	 Gold-plated contact surfaces 	on request	
	Spacing between rows: see I	hole layout	
	Rated current related to rated	d cross-section & min. No. of poles.	
	• P on drawing = pitch		
		component itself. Clearance and creepage of the component itself. Clearance and creepage of the component itself.	distances to other components are to

in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.



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Technical data

Approvals		
Approvals		



ROHS	Conform
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ROHS	Conform	
Downloads		
Approval/Certificate/Docume	nt of	
Conformity	Declaration of the Manufacturer	
Brochure/Catalogue	FL DRIVES EN	
, - 3	MB SMT EN	
	FL DRIVES DE	
	MB DEVICE MANUF. EN	
	FL BUILDING SAFETY EN	
	FL APPL LED LIGHTING EN	
	FL INDUSTR.CONTROLS EN	
	FL MACHINE SAFETY EN	
	FL HEATING ELECTR EN	
	FL APPL_INVERTER EN	
	FL_BASE_STATION_EN	
	FL ELEVATOR EN	
	FL POWER SUPPLY EN	
	FL 72H SAMPLE SER EN	
	<u>PO OMNIMATE EN</u>	
Engineering Data	<u>STEP</u>	
SMT white paper	Download Whitepaper	



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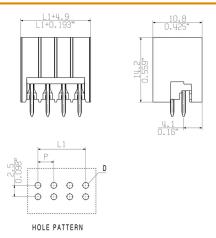
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Drawings

Dimensional drawing





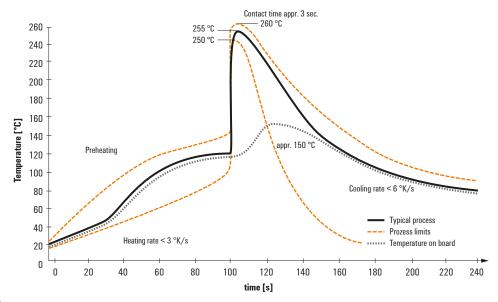
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

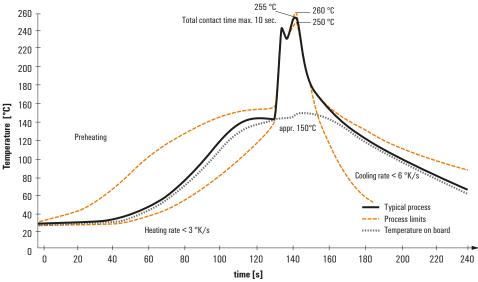
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

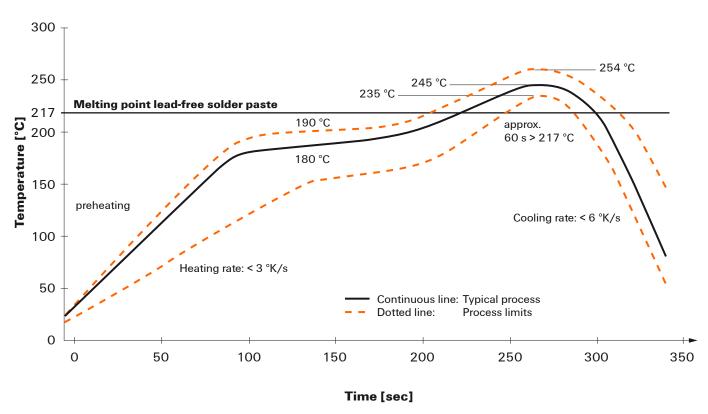


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated′. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.

We reserve the right to make technical changes.